

TAI-SAW TECHNOLOGY CO., LTD.

No. 3, Industrial 2nd Rd., Ping-Chen Industrial District,

Taownan, 324, Taiwan, R.O.C. TEL: 886-3-4690038 FAX: 886-3-4697532

E-mail: tstsales@mail.taisaw.com Web: www.taisaw.com

Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 2.0x1.6 48.0MHz					
TST Part No.: TZ3639	A				
Customer Part No.:					
Customer signature rec	quired				
Company:					
Division:					
Approved by :					
Date:					
Checked by:	Glen Peng	Glen			
Approved by:	Kelly Huang	Glen Kuly Huang			
Date:	10/17/2019	_			

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.



TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 2.0x1.6 48.0MHz

MODEL NO.: TZ3639A REV. NO.: 1

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
Rev.	Rev. Page N/A	Rev. Account Initial release	Date 10/17/19'	Ref. No.	Revised by Glen Peng

RoHS Compliant

ead-free soldering



MODEL NO.: TZ3639A REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL): Level-1

Description and Applications:

Surface mount 2.0mmx1.6mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

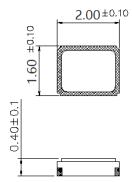
TZ3639A	Specification
Nominal Frequency	48.000000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +125°C
Operating Temperature Range	-30°C to +85°C
Frequency Stability over Operating Temperature Range	+/-10 ppm (referred to the value at 25°C)
Frequency Make Tolerance (FL)	-6 ~ +8 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	22 Ω max
Nominal Drive Level	0.01uW min and 100uW max
Shunt Capacitance (Co)	0.5 pF min and 1.5 pF max
Motional Capacitance (C1)	2.0 pF min and 5.0 pF max
Motional Inductance (L1)	2.0 mH min and 4.0 mH max
Load Capacitance (CL)	8.8 pF
Aging	-2~0 ppm / 5 years
Frequency Perturbation	+/-1 ppm
Frequency drift after reflow	+/-2 ppm
Insulation Resistance	500 MΩ min./DC 100V
Marking	Laser Marking

TAI-SAW TECHNOLOGY CO., LTD.

TST DCC
Release document

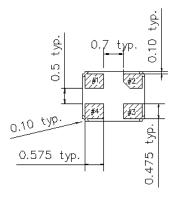
Unit Weight 5.7mg+/-0.5mg

Mechanical Dimensions (mm): Base



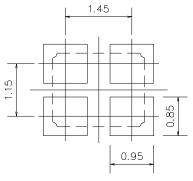


[NOTE] #2, #4 is connected with a metal cover



	Pin connection
#1 Pin	IN/OUT
#2 Pin	GND
#3 Pin	IN/OUT
#4 Pin	GND

Recommended Land Pattern: (unit: mm)

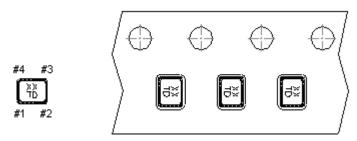


Recommended Land Pattren

Marking:

Line 1: XX; Frequency (48)

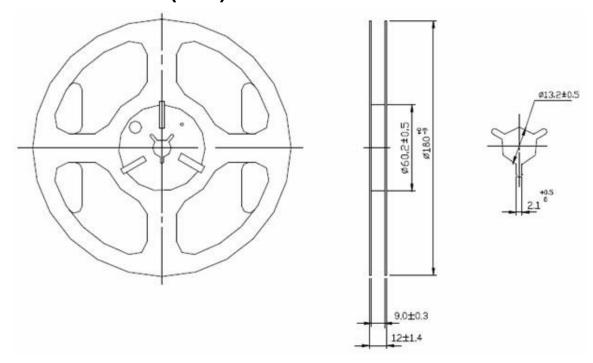
Line 2: T; Traceable Code + D; date Code of Year/Month



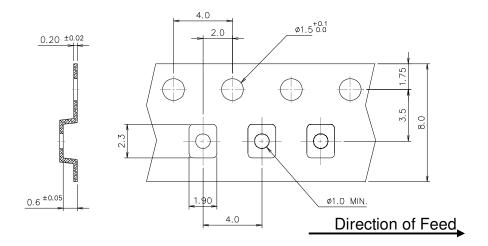
Date Code Table: Year/Month

Year/Month	1	2	3	4	5	6	7	8	9	10	11	12
2018	Α	В	С	D	Е	F	G	Н	J	K	L	М
2019	N	Р	Q	R	S	Т	U	٧	W	Χ	Υ	Z
2020	а	b	С	d	е	f	g	h	i	j	k	m
2021	n	р	q	r	s	t	u	V	w	Х	у	Z

Reel Dimensions (mm):



Tape Dimensions (mm):

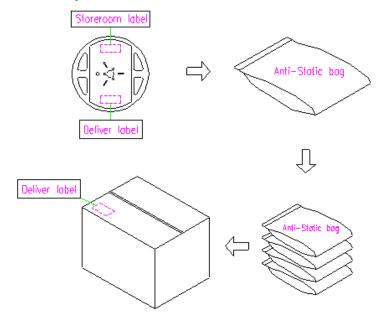


[NOTE]:

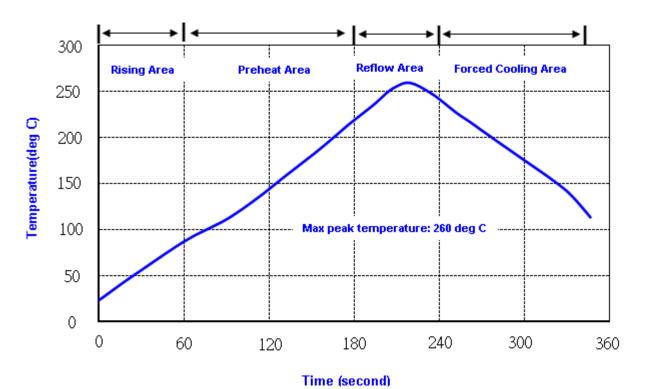
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing:

3K pcs maximum per reel



Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec

2. Temperature: 217+/-5 deg C; Time: $90\sim100$ sec

Reliability Specifications

Test name	Test process / method	Reference standard					
Mechanical characteristics							
resistance to Soldering heat (IR reflow)	Temp./ Duration: 265°C/10sec ×2 times Total time: 4min.(IR-reflow)	=300(301)M(II)					
Vibration	Total peak amplitude: 1.5mm Vibration frequency: 10 to 2000 Hz Sweep period: 20 minute Vibration directions: 3 mutually perpendicular Duration: 2 hr / direc.	MIL-STD 202G method 204					
Mechanical Shock	directions: 3 impacts per axis Acceleration: 3000g's, +20/-0% Duration: 0.3 ms (total 18 shocks) Waveform: Half-sine	MIL-STD 202G method 213					
Solderability	Solder Temperature:265±5 ℃ Duration time: 5±0.5 seconds.	J-STD-002					
Environmental	characteristics						
Thermal Shock	Heat cycle conditions -40 $^{\circ}$ C (30min) \longleftrightarrow 85 $^{\circ}$ C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8					
Humidity test	Temperature : 85 ± 2 ℃ Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103					
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A					
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 °C Duration : 96 hours	IEC 60068-2-1					